



Material	FR-4
Layer	1
Board size	160 x 100mm ± 1mm
Board finished thickness	1.6mm ± 0.1mm
Surface technioque	Spray tin with tin thickness 5~8um
Copper thickness	35um ± 5um
Drilled hole size	1mm ± 0.1mm
Min. spacing	0.5mm ± 0.05mm
Solderability	260°C at 3s - 1.1%
Flammability	V-0
Surface Resistivity	$1.0 \times 10^6 \text{ M}\Omega$
Volume Resistivity	$1.0 \times 10^8 \text{ M}\Omega\text{-cm}$
Arc Resistance	125sec

DATE	REVISION	APPROVAL BY	DIMENSION	mm	PART No	SU527858
			DRAW BY	Camily	NAME	Printed Circuit Board SU527858
			APPROVAL BY	Rikki		
			DATE	08-08-2012		